

This document was generated on 09/21/2021

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Part Number: 0736440209

Status: Active

Overview: HDM Backplane Connector System

**Description:** HDM Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location

A, Polarizing Key Position E, 72 Circuits, Mating Length 6.00mm

**Documents:** 

<u>3D Model</u> <u>Packaging Specification PK-70873-0818-001 (PDF)</u>

3D Model (PDF) RoHS Certificate of Compliance (PDF)

Drawing (PDF)

**Agency Certification** 

CSA LR19980 UL E29179

General

Product Family Backplane Connectors

Series <u>73644</u>
Application Backplane

Comments Standard Press-Fit Component Type PCB Header

Overview HDM Backplane Connector System

Product Name HDM

UPC 822350613163

**Physical** 

Circuits (Loaded) 72
Circuits (maximum) 72

Color - Resin Black, Natural

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

Yes

Material - Metal Phosphor Bronze, Stainless Steel

Material - Plating Mating Gold Material - Plating Termination Gold

Material - Resin High Temperature Thermoplastic

Net Weight 6.400/g Number of Columns 12

Number of Pairs Open Pin Field

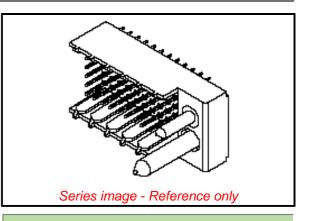
Number of Rows Orientation Vertical PC Tail Length 3.50mm PCB Locator No **PCB** Retention Yes PCB Thickness - Recommended 2.50mm Packaging Type Tube Pitch - Mating Interface 2.00mm Pitch - Termination Interface 2.00mm

Plating min - Mating
Plating min - Termination
Plating min - Termination
Polarized to PCB
Stackable
Surface Mount Compatible (SMC)

2.00film
0.762µm
No
Ves

Temperature Range - Operating -55° to +105°C

Termination Interface: Style Through Hole - Compliant Pin



## **EU ELV**

**Not Relevant** 

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -D(2020)9139-DC (19

Jan 2021)
<a href="Halogen-Free">Halogen-Free</a>
<a href="Status">Status</a>

Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
ROHS Phthalates Not Contained

#### Search Parts in this Series

73644 Series

#### **Mates With**

<u>73632</u> HDM+ Board-to-Board Daughtercard Receptacle. <u>73780</u> HDM Board-to-Board Daughtercard Receptacle

### Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

**Description** Product # Extraction Tool 621001000

**Electrical** 

Current - Maximum per Contact 1.0A
Data Rate 1.0 Gbps
Real Signals (per 25mm) 75

Real Signals (per 25mm) 75
Shielded No
Voltage - Maximum 250V AC

**Solder Process Data** 

Lead-freeProcess Capability N/A

**Material Info** 

**Reference - Drawing Numbers** 

Packaging Specification PK-70873-0818-001

Sales Drawing SDA-73644-XXXX-001, SDA-73644-XXXX-002

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